

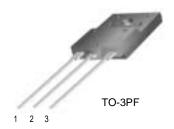
## FFAF20U20DN

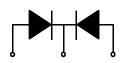
### **Features**

- Ultrafast with soft recovery
- · Low forward voltage

# **Applications**

- Power switching circuits
- Output rectifiers
- Freewheeling diodes
- Switching mode power supply





1. Anode 2. Cathode 3. Anode

### **ULTRA FAST RECOVERY POWER RECTIFIER**

## Absolute Maximum Ratings (per diode) T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 100°C	20	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	200	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

### **Thermal Characteristics**

Symbol		Parameter	Value	Units	
	R <sub>e.IC</sub>	Maximum Thermal Resistance, Junction to Case	2.1	°C/W	

## Electrical Characteristics (per diode) T<sub>C</sub>=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур	Max.	Units
V <sub>FM</sub> *	Maximum Instantaneous Forward Voltage					V
	I <sub>F</sub> = 20A	T <sub>C</sub> = 25 °C	-	-	1.2	
	I <sub>F</sub> = 20A	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	-	-	1.0	
RM *	Maximum Instantaneous Reverse Current					μΑ
	@ rated V <sub>R</sub>	$T_C = 25  ^{\circ}C$	-	-	20	
		$T_C = 25  ^{\circ}C$ $T_C = 100  ^{\circ}C$	-	-	200	
rr	Maximum Reverse Recovery Time		-	-	40	ns
rr	Maximum Reverse Recovery Current		-	-	4.0	Α
Q <sub>rr</sub>	Maximum Reverse Recovery Charge (I <sub>F</sub> =20A, di/dt = 200A/μs)		-	-	80	nC
N <sub>AVL</sub>	Avalanche Energy		0.5	-	-	mJ

<sup>\*</sup> Pulse Test: Pulse Width=300µs, Duty Cycle=2%

# **Typical Characteristics**

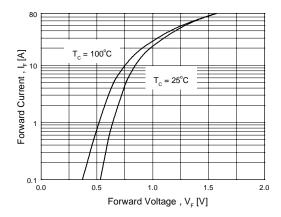


Figure 1. Typical Forward Voltage Drop vs. Forward Current

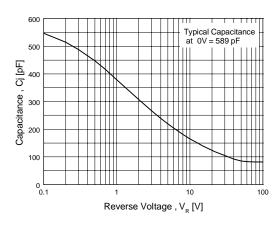


Figure 3. Typical Junction Capacitance

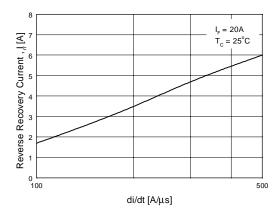


Figure 5. Typical Reverse Recovery Current vs. di/dt

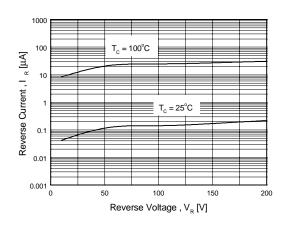


Figure 2. Typical Reverse Current vs. Reverse Voltage

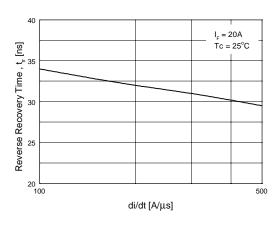


Figure 4. Typical Reverse Recovery Time vs. di/dt

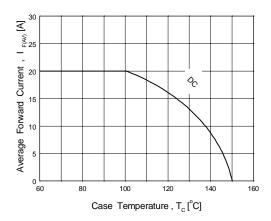
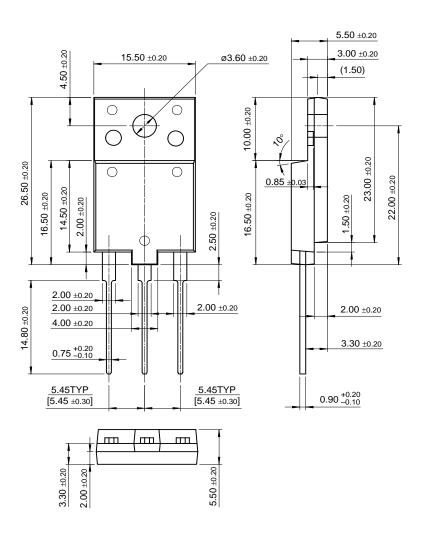


Figure 6. Forward Current Derating Curve

# **Package Dimensions**

# TO-3PF



Dimensions in Millimeters

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